

SEMICONDUCTOR DIGEST

NEWS AND INDUSTRY TRENDS

SEMI MEMS & Imaging Sensors Summit Opens Tomorrow With Sustainability and Innovation in Focus – September 18, 2023

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Innovation will take center stage at the SEMI [MEMS & Imaging Sensors Summit](#) as the event opens tomorrow at the World Trade Center in Grenoble to provide the latest insights into new opportunities for MEMS, imaging and sensors applications and their potential to enable a smarter and more sustainable world. [Registration](#) is open for the September 19-21 conference.

“AI and machine learning are driving a new wave of innovative applications in the development and manufacturing of MEMS and image sensors,” said Laith Altimime, president of SEMI Europe. “We look forward to hosting industry thought leaders as they share their visions for how new advances promise to drive the development of more eco-friendly products and applications.”

The event is hosted by SEMI Europe and the [MEMS & Sensors Industry Group](#), a SEMI Technology Community.

Themed *Ubiquitous Sensing for a Sustainable World*, the MEMS & Imaging Sensors Summit will highlight recent manufacturing advances in MEMS and imaging sensors, as well as how the latest innovations are enabling intelligent applications in various sectors such as entertainment, medical, communications, and mobility.

Featured Speakers

- Hod Finkelstein, Head of Cameras and Depth, Reality Labs, [Meta](#)
- Bernard Kress, Director, Optical Engineering, Augmented Reality Hardware, [Google](#)
- Lia Li, Co-founder and CEO, [Zero Point Motion](#)
- Kilian Bilger, Vice President Engineering Sensor Components, [Bosch](#)
- Theodor Nielsen, CEO, [NIL Technology \(NILT\)](#)
- Isabella Drolz, Vice President of Product Marketing, [Comet Yxlon](#)

- Moti Margalit, CEO, [SonicEdge](#)
- Martin Croome, Vice President of Marketing, [GreenWaves Technologies](#)
- Julia Brueckner, Global Applications & Product Engineering Manager for Packaging & Wafer Business Unit, [Corning Incorporated](#)
- Thomas Russell, CEO, [Mesoline](#)
- Philippe Andreucci, CEO, [Inject Power](#)
- André Henning, Head of R&D, [Siemens Healthineers](#)

Gala Dinner and Networking Opportunities

The SEMI MEMS & Imaging Sensors Summit networking opportunities include a complimentary welcome reception on September 19 in the exhibition area at the WTC and a gala dinner on September 20 at the [Chateau de Sassenage](#).

Industry Leaders Exhibiting at MEMS & Imaging Sensors Summit

- Adeia
- AEMtec
- ASE
- Besi
- CEA-Leti
- Comet Yxlon
- Eurofins | MASER
- EV Group (EVG)
- FormFactor
- Okmetic
- OPTIM Wafer Services
- Panasonic Connect Europe
- Philips MEMS & Micro Devices
- Polytechnik AS
- ProSys
- Pyxalis
- SET Corporation
- Siconnex
- Siemens EDA (represented by EDA Solutions Limited)
- SoftMEMS LLC

- Sumitomo Precision Products
- SUSS Microtec
- VTT
- W. L. Gore & Associates
- Yole Group



Shannon Davis

Shannon, writes, edits and produces Semiconductor Digest's news articles, email newsletters, blogs, webcasts, and social media posts. She holds a bachelor's degree in journalism from Huntington University in Huntington, IN. In addition to her years of freelance business reporting, Shannon has also worked in marketing and public relations in the renewable energy and healthcare industries.

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